# SILICON POWER TRANSISTOR **2SC4346,4346-Z**

# NPN SILICON TRIPLE DIFFUSED TRANSISTOR FOR HIGH SPEED SWITCHING, HIGH VOLTAGE SWITCHING

# DESCRIPTION

The 2SC4346 is a mold power transistor developed for high-speed switching, high voltage switching, and is ideal for use as a driver in devices such as switching regulators, DC/DC converters, and high-frequency power amplifiers.

# ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SC4346	TO-251 (MP-3)		
2SC4346-Z	TO-252 (MP-3Z)		

#### **FEATURES**

- Small package, but can control for high-current
- Low collector saturation voltage V<sub>CE(sat)</sub> = 1.0 V MAX. (Ic = 2.0 A)
- Ultra high-speed switching tf = 0.3  $\mu$ s MAX. (Ic = 2.0 A)
- Base reverse bias safe operating area is wide
  V<sub>CEX(SUS)1</sub> = 450 V MIN. (Ic = 2.0 A)

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	, ,		
Collector to Base Voltage	Vсво	500	V
Collector to Emitter Voltage	Vceo	400	V
Emitter to Base Voltage	Vebo	8.0	V
Collector Current (DC)		5.0	А
Collector Current (pulse)	IC(pulse) Note1	10	А
Base current (DC)	B(DC)	2.5	А
Total Power Dissipation	PT1 (Tc = 25°C)	18	W
Total Power Dissipation	PT2 (TA = 25°C)	1.0 <sup>Note2</sup> , 2.0 <sup>Note3</sup>	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

**Notes 1.** PW  $\leq$  10 ms, Duty Cycle  $\leq$  50%

- 2. Mounted on print board
- 3. Mounted on ceramic substrate of 7.5 mm<sup>2</sup> x 0.7 mm

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ELECTRICAL CHARACTERISTICS (TA = 25°C)

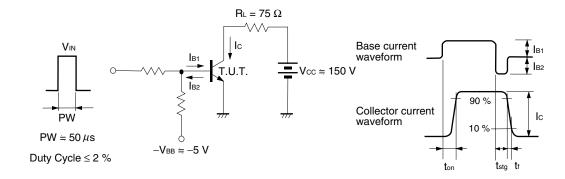
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Collector to Emitter Voltage	VCEO(SUS)	Ic = 2.0 A, Iв1 = 0.4 A, L = 1 mH	400			V
	VCEX(SUS)1	$I_{C} = 2.0 \text{ A}, I_{B1} = -I_{B2} = 0.4 \text{ A},$	450			V
		L = 180 µH, Clamped				
	VCEX(SUS)2	$I_{C} = 4.0 \text{ A}, I_{B1} = 1.0 \text{ A}, -I_{B2} = 0.4 \text{ A},$	400			V
		L = 180 $\mu$ H, Clamped				
Collector Cut-off Current	Ісво	V <sub>CB</sub> = 400 V, I <sub>E</sub> = 0			10	μA
	ICER	$V_{CB}$ = 400 V, R <sub>BE</sub> = 51 $\Omega$ , T <sub>A</sub> = 125°C			1.0	mA
	ICEX1	$V_{CB}$ = 400 V, $V_{BE(OFF)}$ = -5 V			100	μA
	ICEX2	$V_{\text{CB}}$ = 400 V, $V_{\text{BE(OFF)}}$ = $-5$ V, $T_{\text{A}}$ = $125^{\circ}C$			1.0	mA
Emitter Cut-off Current	Іево	V <sub>EB</sub> = 5.0 V, I <sub>C</sub> = 0			10	μA
DC Current Gain Note	hfe1	V <sub>CE</sub> = 5.0 V, Ic = 5 mA	15			
	hfe2	Vce = 5.0 V, Ic = 0.5 A	20		80	
	hfe3	V <sub>CE</sub> = 5.0 V, I <sub>C</sub> = 2.0 A	10			
Collector Saturation Voltage Note	VCE(sat)	Ic = 2.0 A, I <sub>B</sub> = 0.4 A		0.5	1.0	V
Base Saturation Voltage Note	V <sub>BE(sat)</sub>	Ic = 2.0 A, I <sub>B</sub> = 0.4 A		1.0	1.5	V
Turn-on Time	ton	Ic = 2.0 A, RL = 75 Ω			0.7	μs
Storage Time	tstg	I <sub>B1</sub> = −I <sub>B2</sub> = 0.4 A, V <sub>CC</sub> = 150 V			2.5	μs
Fall Time	tr	See Test Circuit			0.3	μs

Note Pulsed

#### **hfe CLASSIFICATION**

Marking	М	L	к
hfe2	20 to 40	30 to 60	40 to 80

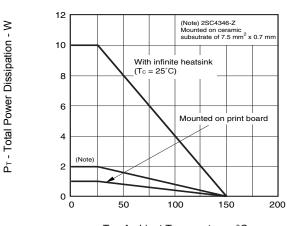
# SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT

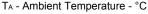


# TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

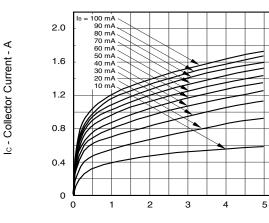
TOTAL POWER DISSIPATION vs.

AMBIENT TEMPERATURE



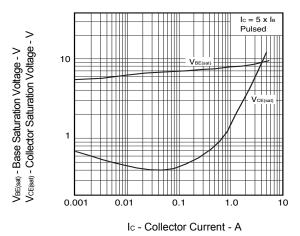


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

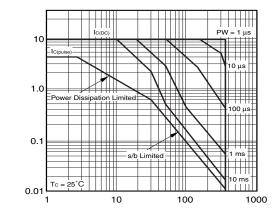


VCE - Collector to Emitter Voltage - V

COLLECTOR AND BASE SATURATION VOLTAGE vs. COLLCTOR CURRENT



FORWARD BIAS SAFE OPERATING AREA

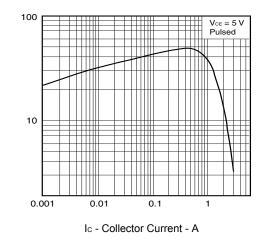


Ic - Collector Current - A

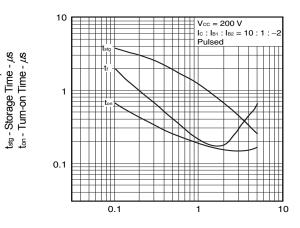
hre – DC Current Gain

VCE - Collector to Emitter Voltage - V

#### DC CURRENT GAIN vs. COLLECTOR CURRENT



# TURN-ON, STORAGE TIME AND FALL TIME vs. COLLECTOR CURRENT

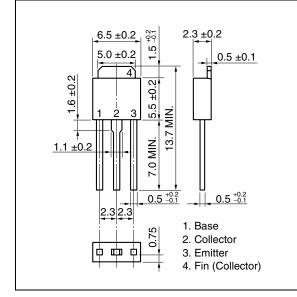


Ic - Collector Current - A

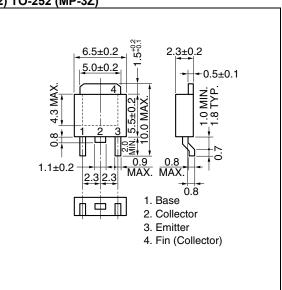
tf - Fall Time - µs

## PACKAGE DRAWINGS (Unit: mm)

## ★ 1) TO-251 (MP-3)







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